

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	4	"6759182":pn. or "6829050":pn. or "6774964":pn. or "6856366":pn.	US-PGPUB; USPAT	OR	ON	2005/05/18 10:18
L3	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:24
L4	3	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:26
L5	6	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (glass near2 transition) and (decomposition)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:27
L7	1	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature same (polymeriz\$5 or cure or curing or cured or harden\$4) same (glass near3 transition) same (decomposition))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:29
L8	0	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz\$5 or cure or curing or cured or harden\$4) and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:29
L9	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:29
L11	54	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz\$5 or cure or curing or cured) and (glass near3 transition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:31
L12	6	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:31

L13	23	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp\$2 or roll\$3 or die))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:32
L14	3	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp\$2 or roll\$3 or die))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:33
L15	89	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((pattern or groove or plate or asperity or microasperity or stamp\$2 or roll\$3 or die or press or pressing or pressed) same (Tg or "T.sub.g" or (glass near2 transition)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:35
L17	3076	(427/162,163.1,164,165).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L18	577	(427/271).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L19	811	(427/277,278).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L20	8314	(427/372.2,374.1,375,384,385.5, 389.7).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L21	1287	(264/1.31,1.1,1.34,1.9).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L22	1277	(349/67,113).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L23	12581	((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:47

L24	2	((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.) and (microasperity or (micro adj asperity))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:47
L25	0	((427/271).CCLS.) and ((349/67, 113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:48
L26	0	((427/277,278).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:48
L27	0	((427/372.2,374.1,375,384,385.5, 389.7).CCLS.) and ((349/67,113). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L28	0	((264/1.31,1.1,1.34,1.9).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L29	2	((427/162,163.1,164,165).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L30	34	((427/162,163.1,164,165).CCLS.) and ((427/271).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L31	19	((427/162,163.1,164,165).CCLS.) and ((427/277,278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L32	64	((427/162,163.1,164,165).CCLS.) and ((264/1.31,1.1,1.34,1.9). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L33	0	((427/277,278).CCLS.) and (reflect\$5 with (LCD or (liquid adj crystal\$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:50
L34	5	((427/277,278).CCLS.) and ((LCD or (liquid adj crystal\$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:50
L35	6	(microasperity or (micro adj asperity)) and (reflect\$5 with (LCD or (liquid adj crystal\$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:51
L36	48	((349/67,113).CCLS.) and (pattern\$3 with (stamp\$3 or master or emboss\$4 or roll\$3))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:52

L38	78	((reflect\$5 with (LCD or (liquid adj crystal\$4 adj display))) and ((pattern\$3 or resin\$4 or polyimide or polymer\$2) with (stamp\$3 or master or emboss\$4 or roll\$3)) and (((427/162,163.1, 164,165).CCLS.) ((427/271).CCLS.) ((427/277,278).CCLS.) ((427/372.2,374.1,375,384,385.5, 389.7).CCLS.) ((264/1.31,1.1,1. 34,1.9).CCLS.) ((349/67,113). CCLS.))) not (((349/67,113).CCLS.) and (pattern\$3 with (stamp\$3 or master or emboss\$4 or roll\$3)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:54
L39	1	"5071597".pn:	US-PGPUB; USPAT	OR	ON	2005/05/18 10:58
L40	18	((427/277,278).CCLS.) and ((glass adj transition) or Tg or "T.sub.g" or "T.sub.G")	US-PGPUB; USPAT	OR	ON	2005/05/18 10:59
L41	18	((427/277,278).CCLS.) and ((glass adj transition) or Tg or "T.sub.g" or "T.sub.G")	US-PGPUB; USPAT	OR	ON	2005/05/18 10:59
L43	1003	((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing) near3 temperature))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:06
L44	0	(((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing) near3 temperature))) and ((427/277, 278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:06
L45	78	(((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing) near3 temperature))) and (((427/162, 163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:06

L46	46	((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing or reaction) near3 temperature)) and ((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near6 (glass adj transition)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:10
L47	1149	((coat\$3 or deposit\$3 or spincoat\$3) with (temperature) with (lower or below or under) near4 ((polymeriz\$5 or curing or reaction) near3 temperature))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:10
L48	37	((coat\$3 or deposit\$3 or spincoat\$3) with (temperature) with (lower or below or under) near4 ((polymeriz\$5 or curing or reaction) near3 temperature with (begin\$5 or initiat\$8 or start\$5 or commenc\$5)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:11
L49	50	((coat\$3 or deposit\$3 or spincoat\$3) with (temperature) with (lower or below or under) near4 ((polymeriz\$5 or curing or reaction) near3 temperature with (begin\$5 or initiat\$8 or start\$5 or commenc\$5)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:11
L50	1	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((427/277,278). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:16
L51	5	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:16

L53	53	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex)) not (((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:17
L55	2	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:18
L56	204	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master or emboss\$5))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:19

L57	85	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press or pressing or pressed or stamp\$3 or roll\$3 or die or master or emboss\$5)) not (((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex)) not (((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:20
L58	7	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (coat\$3 or deposit\$4 or film or layer or apply\$3 or application) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:21
L59	78	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:22
L60	30	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:23
L61	41	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften\$4)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:23

L62	13	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften\$4)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:24
L63	35	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:24
L65	43	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:24
L66	29	((cure or cured or curing or harden\$3 or polymeriz\$5)) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2))) same ((stamp\$5 or emboss\$5 or roll\$4 or die or press or pressed or pressing) near6 (pattern\$4 or convex or concave or indent\$6))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:25
L68	79	(((cure or cured or curing or harden\$3 or polymeriz\$5)) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2))) same ((stamp\$5 or emboss\$5 or roll\$4 or die or press or pressed or pressing))) and (((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:26
L70	80	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (Tg or "T.sub.g")	US-PGPUB; USPAT	OR	ON	2005/05/18 11:27

L72	91	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:28
L74	5	(stress\$3) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:29
L75	1	(relax\$7) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:29
L76	20	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near4 (soften\$4) with (Tg or 'T.sub.g' or (glass near2 transition))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:29
L77	0	(stress\$3 or relax\$7) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:30
L78	33	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:30
L80	355	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))) not ((coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:30
L82	59	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))) same (stamp\$5 or pattern\$4 or press\$3 or die or emboss\$5)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:32

L84	13	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp\$5 or pattern\$4 or press\$3 or die or emboss\$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:32
L85	14	(spincoat\$3 or (spin adj coat\$3)) with (resin\$5 or monomer\$3 or prepolymer\$4 or solution or liquid with (temperature) with (lower or below or under) near4 (cure or cured or curing or polymeriz\$6 or harden\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:32
L87	14	(spincoat\$3 or (spin adj coat\$3)) with (temperature) near3 (lower or below or under) near4 (cure or cured or curing or polymeriz\$6 or harden\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:33
L88	13	((coat\$4 or spincoat\$4 or deposit\$5 or film or layer or apply\$4 or application) with (polymer\$2 or resin\$4 or plastic or oligomer\$4 or monomer\$4 or prepolymer\$4) with (temperature) with (below or lower or under or beneath or less) with (cure or cured or curing or harden\$4 or polymeriz\$6 or reaction) with (start\$4 or initiat\$7 or begin\$5 or commenc\$6)) and ((heat\$5 or cured or cure or curing or harden\$5 or bake or baked or baking or polymeriz\$7) with (temperature) with (above or greater or higher or over or increas\$5) with (Tg or "T.sub.g" or (glass adj transition))) and ((microasperity or pattern\$4 or emboss\$4 or stamp\$4 or master or die or mold\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:43
L89	5657	((heat\$5 or cured or cure or curing or harden\$5 or bake or baked or baking or polymeriz\$7) with (temperature) with (above or greater or higher or over or increas\$5) with (Tg or "T.sub.g" or (glass adj transition))) and ((microasperity or pattern\$4 or emboss\$4 or stamp\$4 or master or die or mold\$4) with (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:45

L90	1469	((heat\$5 or cured or cure or curing or harden\$5 or bake or baked or baking or polymeriz\$7) with (temperature) with (above or greater or higher or over or increas\$5) with (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or pattern\$4 or emboss\$4 or stamp\$4 or master or die or mold\$4) with (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:51
L91	1180	((heat\$5 or cured or cure or curing or harden\$5 or bake or baked or baking or polymeriz\$7) with (temperature) with (above or greater or higher or over or increas\$5) near3 (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or pattern\$4 or emboss\$4 or stamp\$4 or master or die or mold\$4) with (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:46
L92	39	L91 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:46
L93	92	((heat\$5 or cured or cure or curing or harden\$5 or bake or baked or baking or polymeriz\$7) with (coats\$5 or film or layer or deposit\$5) with (temperature) with (above or greater or higher or over or increas\$5) with (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or emboss\$4 or stamp\$4) with (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:02
L94	1299	((microasperity or emboss\$4 or stamp\$4) with (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic) with (after or before or prior or subsequent\$4 or previous\$4) with (cure or cured or curing or polymeriz\$8 or harden\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:04

L95	11	((microasperity or emboss\$4 or stamp\$4) with (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic) with (after or before or prior or subsequent\$4 or previous\$4) with (cure or cured or curing or polymeriz\$8 or harden\$5)) same (Tg or "T.sub.g" or (glass adj transition))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:08
L96	262	((microasperity or emboss\$4 or stamp\$4) near3 (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic) with (after or before or prior or subsequent\$4 or previous\$4) near2 (cure or cured or curing or polymeriz\$8 or harden\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:32
L97	25	(((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5 or soften\$5 or melt\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp\$5 or emboss\$5 or pressed or press or pressing or microasperity or (micro adj asperity)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:13
L98	71	(((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5 or soften\$5 or melt\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp\$5 or emboss\$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold\$4 or die or pattern\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:15

L99	91	((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5 or soften\$5 or melt\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp\$5 or emboss\$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold\$4 or die or pattern\$4 or imprint\$5 or print\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:38
L100	15	L96 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:31
L101	247	L96 not L100	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:31
L102	13	((microasperity or emboss\$4 or stamp\$4) near3 (coat\$4 or film or layer or resin\$5 or polymer\$5 or plastic) with (after or before or prior or subsequent\$4 or previous\$4) near2 (cure or cured or curing or polymeriz\$8 or harden\$5)) same (Tg or soften\$5 or melt\$5 or "T.sub.g" or (glass near2 transition))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:33
L103	1180	((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften\$4 or melt\$5 or flow\$9)) same (stamp\$5 or emboss\$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold\$4 or die or pattern\$4 or imprint\$5 or print\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:48
L104	41	L103 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:41

L105	382	((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften\$4 or melt\$5 or flow\$9)) same (stamp\$5 or emboss\$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold\$4 or die or pattern\$4 or imprint\$5 or print\$5))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:49
L106	34	((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften\$4 or melt\$5 or flow\$9)) same (stamp\$5 or emboss\$5 or (pressed or press or pressing or mold\$4 or die) near5 (microasperity or (micro adj asperity) or pattern\$4 or imprint\$5)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:53
L107	101	((cure or cured or curing or polymeriz\$8 or harden\$5) near3 (coat\$4 or film or layer)) same ((heat\$5) with (coat\$5 or film or layer or polymer\$4 or resin\$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften\$4 or melt\$5 or flow\$9)) same (stamp\$5 or emboss\$5 or (pressed or press or pressing or mold\$4 or die) near5 (microasperity or (micro adj asperity) or pattern\$4 or imprint\$5)))	US-PGPUB; USPAT	OR	ON	2005/05/18 12:54
L108	92	L107 not L104	US-PGPUB; USPAT	OR	ON	2005/05/18 12:54